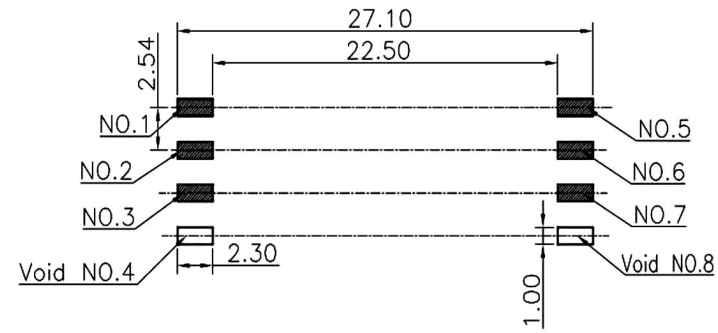


Specifications
 Current Rating: 1Amp
 Insulation Resistance: 1000MΩ Min.
 Dielectric Withstanding: 250VAC
 Contact Resistance: 100mΩ Max
 Operating Temperature: -40°C to +85°C
 Max Process Temp: 200°C for 20~30 sec.
 (230°C for 10~15seconds)

Materials
 Contact Material: Phosphor Bronze
 Insulator Material: High Temperature Thermoplastic, UL 94V-0
 LCP Or Equivalent material (Housing 1)
 LCP Or Equivalent material (Housing 2)

Recommended P.C.Board Layout
 (Tolerance: ±0.05)



RoHS Compliant		HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准	SCALE 比例 参考	GENERAL TOLERANCE	PART NAME 品名
DWG. 製圖 Betty		X: ±5.0° X: ±0.30	SIM CARD BLOCK TYPE HINGED COVER 6PIN
DATE 制表日 2015/07/29	UNIT 單位 MM	.X: ±3.0° X: ±0.25	SMT TYPE H=2.5mm W/O SWITCH W/O LOCATING POST
	PAGE 張數 1 OF 1	.XX: ±2.0° .XX: ±0.15	BLACK COLOR INSULATOR MATERIAL: LCP ROHS
		.XXX: ±1.0° .XXX: ±0.10	PART NO. C0639-06DXBX00N
		SIZE. 紙張尺寸 A 4	料號
		REV. 版次 A	